

Editorial Statement of Peer Review ⁺

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In submitting conference proceedings to *Engineering Proceedings*, the volume editors of the proceedings certify to the publisher that all papers published in this volume have been subjected to peer review administered by the volume editors. Reviews were conducted by expert referees to the professional and scientific standards expected of a proceedings journal.

- Type of peer review: Single blind
- Conference submission management system: Microsoft CMT
- Number of submissions sent for review: 38
- Number of submissions accepted: 20
- Acceptance rate (number of submissions accepted/number of submissions received): 52.63%
- Average number of reviews per paper: 2
- Total number of reviewers involved: 21
- Peer-review process and regulations: The review process was single-blinded. The main criteria of acceptance were the originality, clarity of the presentation and the findings.

Conflicts of Interest: The authors declare no conflict of interest.

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